



Product Change Notification

Change Notification #: 1188911-00
Change Title: Select Intel® Server System R2312WF0NPR, Single
PCN 1188911-00, Product Material, Add second source for Voltage Regulator on Hot Swap Backplane
Date of Publication: February 25, 2022

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material *	March 15, 2022
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the items listed in the "Products Affected" table.

- Adding a second source for a Voltage Regulator (VR) controller on the Hot swap backplane (HSBP). The new controller is identical in function to the previous one but differs in form factor.
- The interposer PCB supporting a new Programmable System-On-Chip (PSOC) is also being used in this version.
- The new components have passed all functional and electrical validation tests successfully.
- As a result, we are adding as alternate the following PBA: H88392-411.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
Intel® Server System R2312WF0NPR, Single	R2312WF0NPR	986054	K40016-008	H88392-351 H88392-352	K40016-009	H88392-351 H88392-352 H88392-411

PCN Revision History:

Date of Revision:

February 25, 2022

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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